Docket No.:	
	DECLARATION AND POWER OF ATTORNE
As a below name	ed inventor, I hereby declare that:
My residence, pr	ast office and entrenship are as stand below next to my name,
	the original, first and sole inventor (If only one name is listed below) or an original

und, first and joint mient is sought on the invention enuded PLANT SIMD-SPECIFIC EXPRESSION PROMOTER DERIVED FROM SESAME AND SHED-SPHCIFIC EXPRESSION VECTOR COMPRISING THE PROMOTER, the specification of which ns Application Seral No. _ _ [] is attached beseto [] was filed on _ (if applicable) amended on I hereby state that I have reviewed and understand the contents of the above identified specification, including the claims, as amended by any amendment referred to above. I acknowledge the duty to disclose information which is known to me to be material to patentishinty in accordance with Title 37, Code of Federal Regulations, Section 1.56(a). I hereby claim foreign priority benefits under 35 U.S.C. 119(a) (d) or 365 (h) of any foreign application(s) for patent or inventor's coroficate, or 365(a) of any PCT International application which designated at least one country other than the United States of America, listed below and have also identified below, by checking the linx, any foreign application for parent or inventor's configure, or of any PCT International application having a filing date before that of the application on which priority is claimed. Foreign Filing Date Prior Poreign Application(s): Month/Day/Yenr Number Country November 11, 2002 2002-0069589 Koren April 18, 2003 Korea 2003-0024776 I hereby claim the benefit under 35 U.S.C. 119(e) of any United States provisional application(s) listed below. Filing Date (Month/Day/Year) Application Number(a): I hereby claim the benefit under 35 U.S.C. 120 of any United States application(s), or 365(c) of any PCI. international application designating the United States of America, listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States or PCT international application in the manner provided by the flest paragraph of 35 U.S.C. 112, I acknowledge the duty to disclose information which is material to patentability as defined in 37 CPR 1.56 which became available between the filing date of the prior application and the national or PCT International filing date of this application.

Prior U. S. Application or PCT Parent Number

Filing Date (Month/Day/Year)

Parent Parent Number (if applicable)

PCT/KR2003/002415

November 11, 2003

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true, and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such wilful false statements may jeopardize the validity of the application or any parent issued thereon.

I hereby appealed the following attorney(s) and/or agent(s) associated with Customer Number 34610 with full power of substitution and revocation, to prosecute this application and to transact all husiness in the Patent and Trademark Office connected therewith. Direct all correspondence to Customer Number 34610.

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